

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

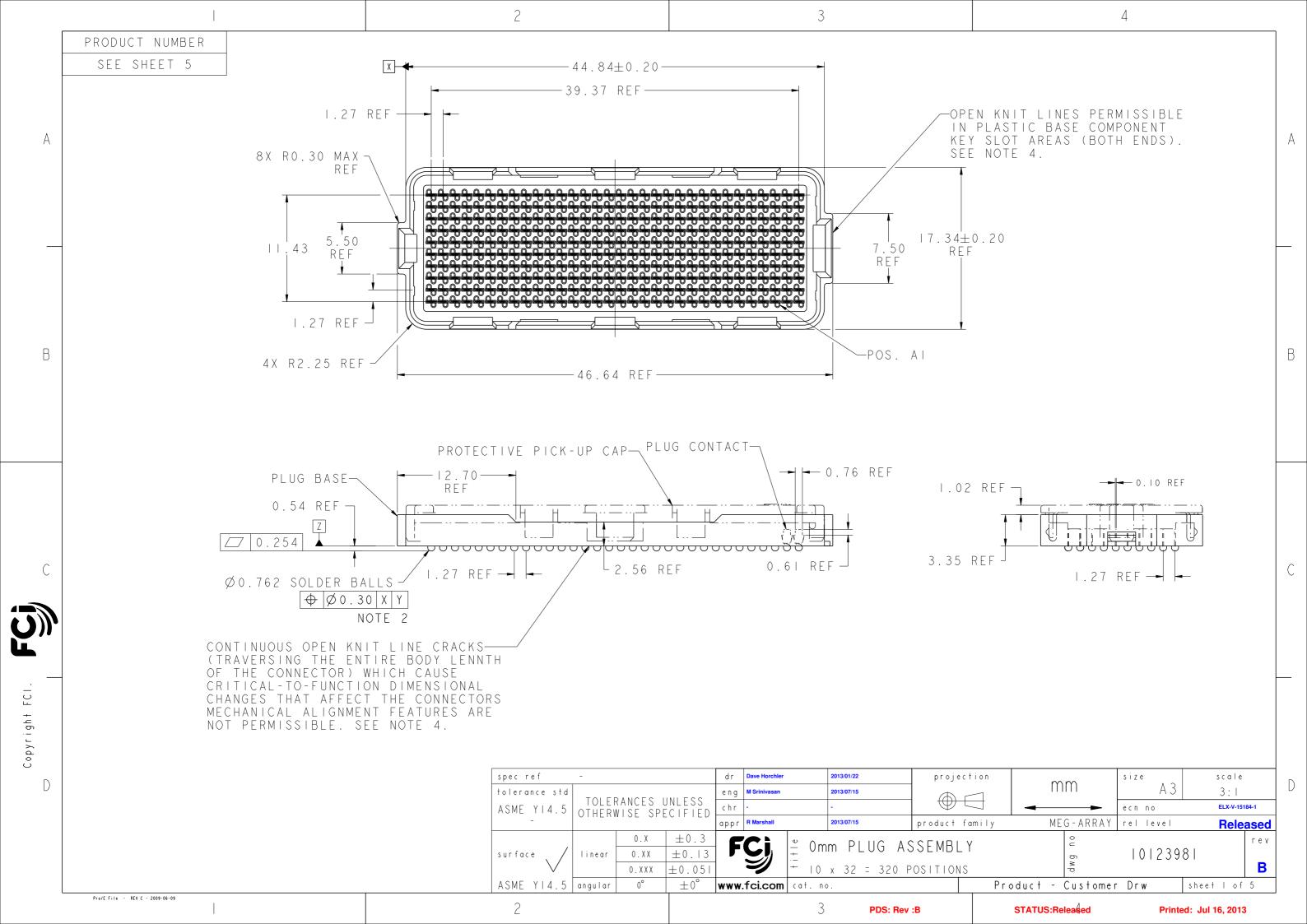
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

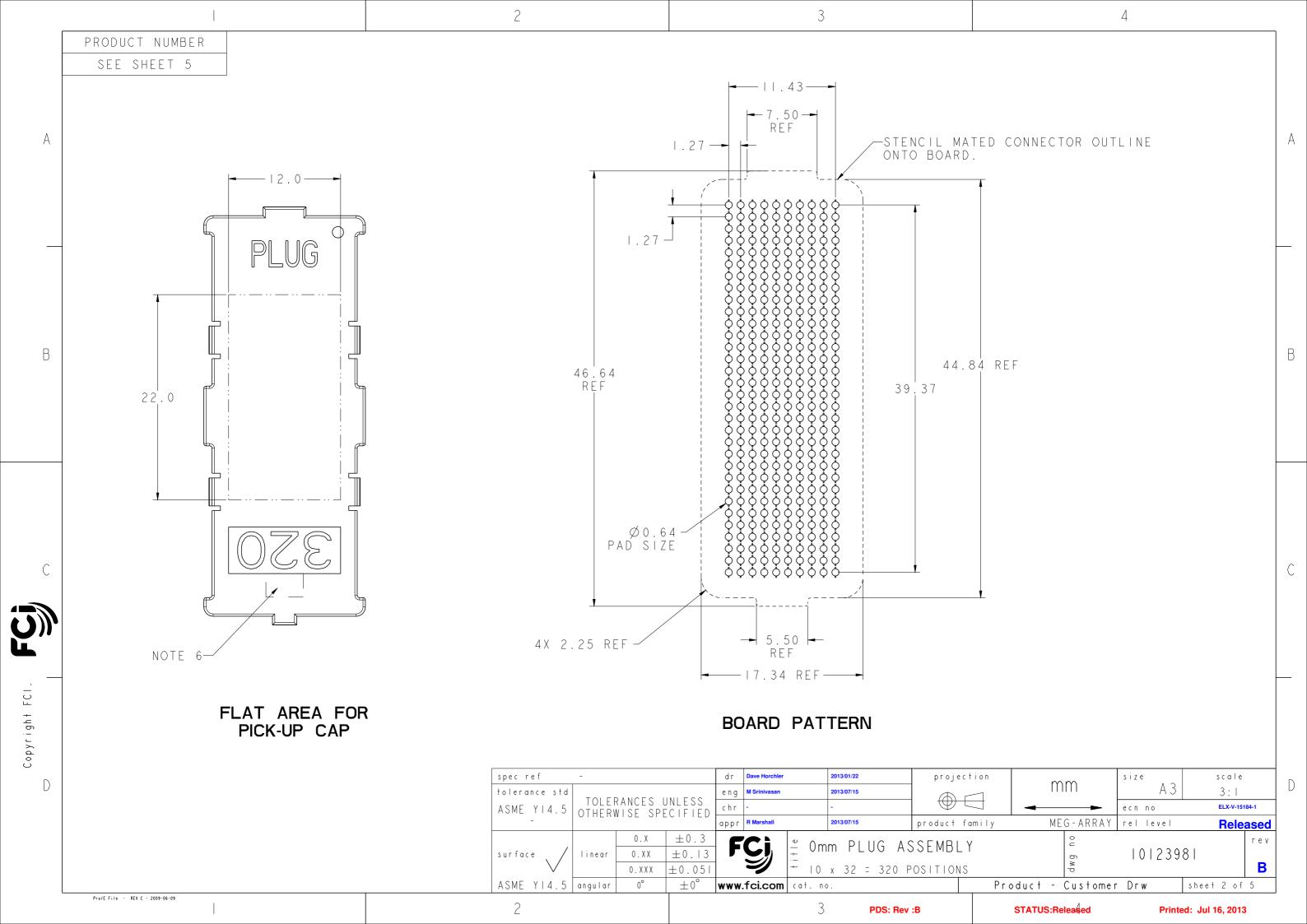
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

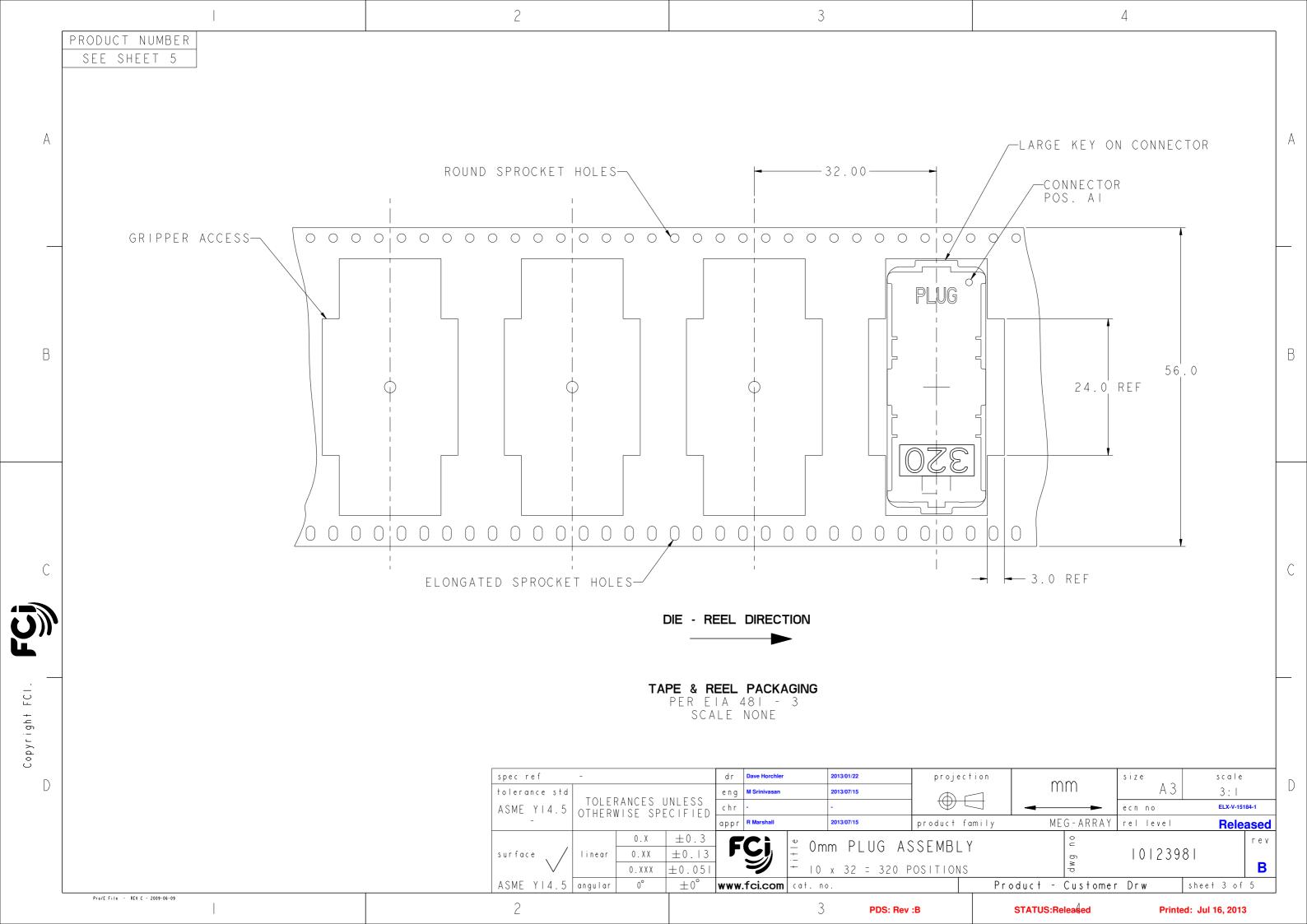


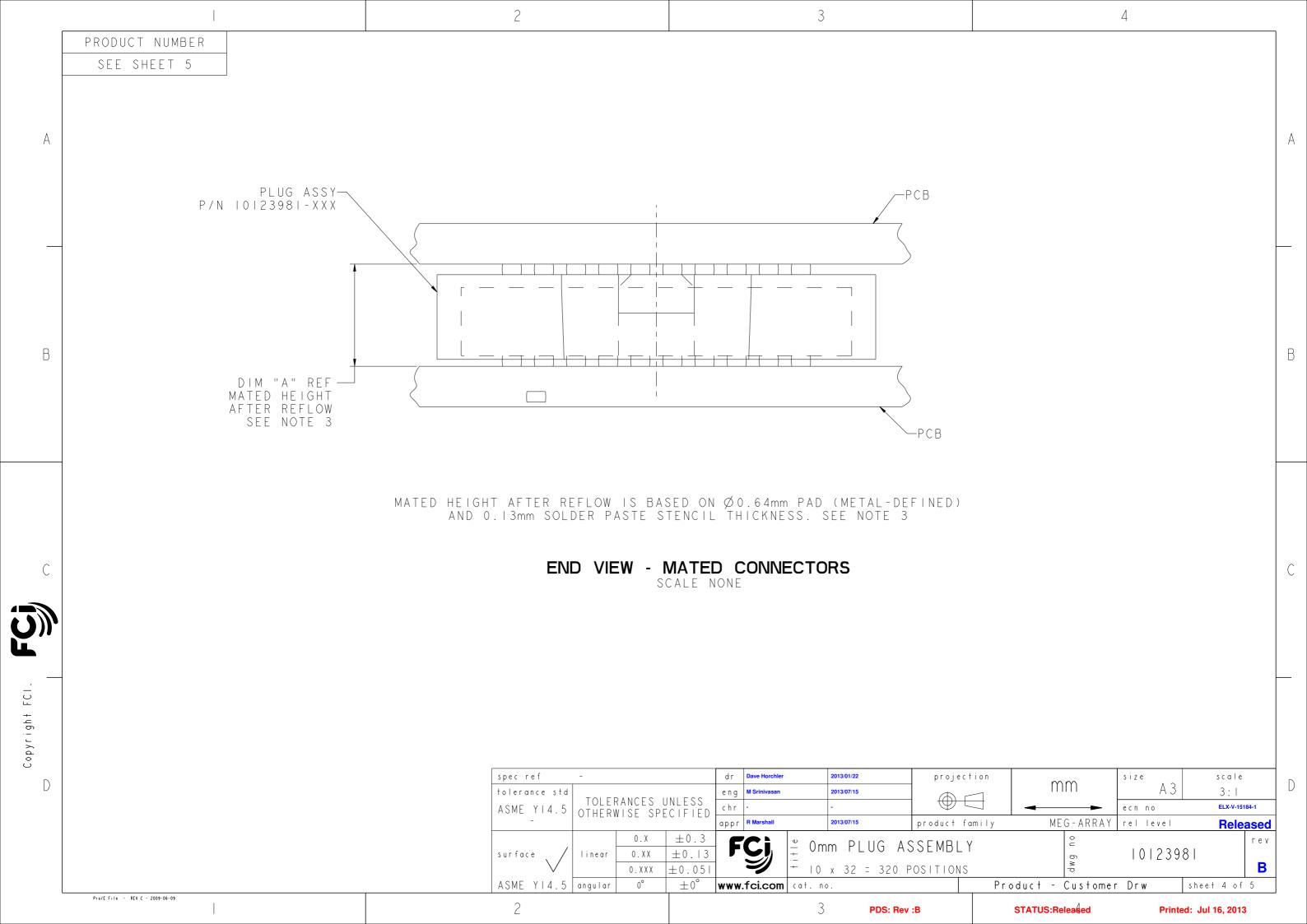












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A _	PRODUCT NUMBER	PICK-UP CAP (NATURAL OR BLACK IN COLOR)	CONTACT PLATING AND THICKNESS		_L NOTES				
	10123981-002	YES	15u" (.38um) A	u SnPb					
	10123981-002LF	YES	15u" (.38um) A	u LEAD FREI	4 AND 5				
	10123981-092	YES	15u" (.38um) GX	(T SnPb					
	10123981-092LF	YES	15u" (.38um) GX	(T LEAD FRE	4 AND 5				l A
	10123981-102	YES	30 u " (.76 um) A	u SnPb					, ,
	10123981-102LF	YES	30 u " (.76 um) A	u LEAD FRE	4 AND 5				
	10123981-192	YES	30u" (.76um) GX						
	10123981-192LF	YES	30 u " (.76 um) G X		E 4 AND 5				
	10123981-202		50 u " (l. 27 um) Au SP		8				
В	10123981-202LF		50 u'' (l. 27 um) Au SP		·	3			_
	10123981-292		50 u'' (1.27 um) GXT SI		8				
	10123981-292LF		50 u'' (1.27 um) GXT SI						
	10123981-A02	YES	30u" (.76um) Au SPI		CUSTOMER SPEC				
	10123981-A02LF	YES	30u" (.76um) Au SPI	ECIAL LEAD FREI	CUSTOMER SPEC	CIAL			
	NOTES:								В
	(I.)MATERIAL: HOUSING: LCP-NATURAL CONTACT: COPPER ALLOY								
	PLATING: CONTACT: SOLDER E	5μ" (0.38μm) G% BALL: LEAD FREE 95.5Sn/4Ag/(XT OVER NI UNDERPLA	TE					
Copyright FCI.	2. SOLDER BALLS WILL NOT HAVE PERFECT SPHERICAL SHAPES DUE TO REFLOW ATTACHMENT.								
	(3) MATED HEIGHT EFFECTED BY CUSTOMER'S PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE, & SOLDER PASTE.								
	SPECIFICAT NOT SOLDER DUE TO A H PRODUCT IS LEADED OR	TION GS-20-033 LEAR R PROPERLY IN A LEA HIGHER REFLOW TEMA B THEREFORE NOT BA	LOW FCI APPLICATION AD FREE SOLDER BALL EADED SOLDER PROCES PERATURE. LEAD FREE ACKWARDS COMPATIBLE APPLICATIONS. REFERION.	S WILL S WITH					C
	OTHER COUN PRODUCT ME CODE NUMBE	NTRY REGULATIONS A SETING THIS DIRECT	N UNION DIRECTIVES AS DESCRIBED IN GS- TIVE IS IDENTIFIED PART BY HAVING AN DSITION.	47-0004 IN THE LOT					
		OMPANY LOGO TO BE E AREA SHOWN.		pec ref -	d p Dave Horchier	2013/01/22 project	ion	size scale	
		CT SPEC GS-12-100 CE INFORMATION.	PER TEST AND	olerance std TOLERANCES (SME YI4.5 OTHERWISE SF	UNLESS chr -	2013/07/15		size scale 3:1 ecn no ELX-V-15184-1	
	MEET THE CENTRAL C	OR INDICATED -2XX REQUIREMENTS OF (OFFICE ENVIROMENT CY). THIS SERIES H	GR-1217-CORE, , (25 YEARS LIFE S HAS SPECIAL	urface $\begin{array}{c c} - & & & & & & & & \\ & & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & \\ & & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & \\ & & \\ & \\ & \\ & & \\ & $	±0.3 FC = 0	product for produc		rel level Released rev	
	Pro/E File - REV C - 2009-06-09		A)				'	J
				۷		3 PDS: Rev :B	STATUS:Released	Printed: Jul 16, 2013	